

FACILITATING THE SPREAD OF ENCAPSULANT  
BETWEEN SURFACES OF ELECTRONIC DEVICES

Abstract of the Disclosure

- 5 An electronic device having an extensive narrow  
passageway may be effectively encapsulated by forming  
openings in one or more of the surfaces defining the  
encapsulation region. Encapsulation material may then be  
injected through these openings to fill a narrow, difficult  
to access region between two surfaces being encapsulated.
- 10 In some cases, the encapsulant may be applied  
progressively, starting with a central port and applying  
the encapsulant in a radially expanding front through  
radially displaced ports.